	Type	Hits	Search Text	DBs	Time Stamp	Comments
Н	IS&R	5	("5844684").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 12:17	
	BRS	2	"20040167722"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:50	
n	BRS	1247	702/23,32,33,40,179.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 15:51	
4	BRS	2141	382/130,131,132,238,300.cc	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 15:52	
ഹ	BRS	6617	356/601-625,635- 640,237.1,237.2.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:49	
Q	BRS	1011	702/for.134,for.135,for.13 7,for.139,for.156.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:48	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
7	BRS	. 96	250/341.4.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:49	
_	BRS	326	438/7.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:24	
<u></u>	BRS	2007	interpolat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19	
10	BRS	35	"356"/\$.ccls. and interpolat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 15:51	
H H	BRS	1011	702/for.134, for.135, for.13 7, for.139, for.156.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 15:48	
12	BRS	2276	382/130,131,132,238,300.cc	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 15:49	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
13	BRS .	6836	356/601-625,635- 640,237.1,237.2.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:49	
14	BRS	86	250/341.4.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:49	
15	IS&R	2	("5844684").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:49	
16	BRS	5	"20040167722"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:50	
17	BRS	2152	interpolat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:50	
18	BRS	41	"356"/\$.ccls. and interpolat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:51	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
10	BRS	2276	382/130,131,132,238,300.cc	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:52	
20	BRS		702/23,32,33,40,179.ccls. or 702/for.134,for.135,for.13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 15:52	
21	BRS	4626	3,40,179.ccls. ,for.135,for.13 or.156.ccls. or ,132,238,300.cc	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:53	
22	BRS	11447	40,179.ccls. [or.135,for.13] [.156.ccls. or.32,238,300.cc] [.1-625,635-	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:53	

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
23	BRS	11541	702/23,32,33,40,179.ccls. or 702/for.134,for.135,for.13 7,for.139,for.156.ccls. or 382/130,131,132,238,300.cc 1s. or 356/601-625,635- 640,237.1,237.2.ccls. or 250/341.4.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:55	
24	BRS	11880	702/23,32,33,40,179.ccls. or 702/for.134,for.135,for.13 7,for.139,for.156.ccls. or 382/130,131,132,238,300.cc 1s. or 356/601-625,635- 640,237.1,237.2.ccls. or 250/341.4.ccls. or	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:55	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
25	BRS	61	(702/23,32,33,40,179.ccls. or vor. 134, for.135, for.13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:56	
. 92	BRS	6	(702/23,32,33,40,179.ccls. or 702/for.134,for.135,for.13 702/for.134,for.135,for.13 7,for.139,for.156.ccls. or 382/130,131,132,238,300.cc 1s. or 356/601-625,635-640,237.1,237.2.ccls. or 250/341.4.ccls. or and diffracts3 with model\$1 and diffract\$3 with structure\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 15:56	

Туре	Hits	Search Text	DBs	Time Stamp	Comments
	4	or 702/23,32,33,40,179.ccls. or 702/for.134,for.135,for.13 7,for.139,for.156.ccls. or 382/130,131,132,238,300.cc 1s. or 356/601-625,635- 640,237.1,237.2.ccls. or 250/341.4.ccls. or 438/7.ccls.) and interpolat\$3 with model\$1 and diffract\$3 with structure\$1 and (semiconductor\$1 or wafer41 or IC\$1 or integrated adj circuit\$1 or chip\$1 or die\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:05	
	7.5	Levenberg-Marquardt with algorithm and interpolat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 16:11	
	0	Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical with optical	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 16:12	
	BRS BRS BRS	7 5 0	702/for.134, for.135, for.13 7, for.139, for.156.ccls. or 382/130,131,132,238,300.cc 1s. or 356/601-625,635- 640,237.1,237.2.ccls. or 250/341.4.ccls. or 438/7.ccls.) and interpolat\$3 with model\$1 and diffract\$3 with structure\$1 and (semiconductor\$1 or wafer41 or IC\$1 or integrated adj circuit\$1 or chip\$1 or die\$1) Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical with optical	702/for.134, for.135, for.13 7, for.139, for.156.ccls. or 382/130,131,132,238,300.cc 1s. or 356/601-625,635- 640,237.1,237.2.ccls. or 250/341.4.ccls. or 438/7.ccls.) and interpolat\$3 with model\$1 and diffract\$3 with structure\$1 and (semiconductor\$1 or wafer41 or IC\$1 or integrated adj circuit\$1 or chip\$1 or die\$1) Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical with optical	702/for.134,for.135,for.13 7,for.139,for.156.ccls. or 382/130,131,132,238,300.cc ls. or 356/601-625,635- 640,237.1,237.2.ccls. or 438/7.ccls.) and interpolat\$3 with model\$1 IBM_TDB and diffract\$3 with model\$1 IBM_TDB and diffract\$3 with model\$1 IBM_TDB and diffract\$3 with structure\$1 and (semiconductor\$1 or wafer41 or IC\$1 or integrated adj circuit\$1 or chip\$1 or die\$1) US-PGPUB; Levenberg-Marquardt with USPAT; EPO; algorithm and interpolat\$3 JPO; DERWENT; algorithm and interpolat\$3 USPAT; EPO; and theoretical with US-PGPUB; optical IBM TDB IBM TDB

Type	Hits	Search Text	DBs	Time Stamp	Comments
BRS	5 0	Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20	
BRS	28	Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical and (iterative\$2 or repeat\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 16:12	-
BRS	7	Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical and (iterative\$2 or repeat\$3) with best with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:13	
BRS	18	Levenberg-Marquardt with algorithm and interpolat\$3 and theoretical and (iterative\$2 or repeat\$3) and best with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:14	
BRS	7	Levenberg-Marquardt with algorithm and interpolat\$3 land theoretical and (iterative\$2 or repeat\$3) and best with fit\$4 and diffract\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19	

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
35	BRS	0	diffract\$3 with semiconductor\$1 and interpoat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 16:26	
36	BRS	352	438/7.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/19 16:24	
37	BRS	14	database with interpolat\$3 and theoretical and (iterative\$2 or repeat\$3) and best with fit\$4 and diffract\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:26	
38	BRS	m	diffract\$3 with semiconductor\$1 and interpolat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/19 16:30	
6 8	BRS	9	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and interpolat\$3 with contin\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:33	

Type	Hits	Search Text	DBs	Time Stamp	Comments
BRS	7	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and interpolat\$3 with contin\$5 and (iterative\$2 or repeat\$2) with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/19 16:34	
BRS	4 6	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and interpolat\$3 and (contin\$5 or iterative\$2 or repeat\$2) with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	
BRS	4 6	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and interpolat\$3 and (contin\$7 or iterative\$2 or repeat\$4) with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	

Туре	Hits	Search Text	DBs	Time Stamp	Comments
0		diffract\$3 with structure\$1 and (semiconductor\$1 or untegrated adj circuit\$1 or die\$1 or chip\$1) and interpolat\$3 and (contin\$7 or iterative\$2 or repeat\$4) with fit\$4 and optical with nsignal\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	
8 8	ω	\$1 d in\$7 nd	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
45.	BRS	7	or rcuit\$1 1) and (contin\$7 t\$4 and al\$1 with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 09:10	
46	BRS	7	with and tor\$1 or IC\$1 or adj circuit\$1 chip\$1) and 3 and (contin\$7 e\$2 or ith fit\$4 and h signal\$1 with and (profile\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	

Туре	Hits	Search Text	DBs	Time Stamp	Comments
BRS	7	diffract\$3 with structure\$1 and (semiconductor\$1 or untegrated adj circuit\$1 or die\$1 or chip\$1) and interpolat\$3 and (contin\$7 or iterative\$2 or repeat\$4) with optical with signal\$1 with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	
BRS	30	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (determin\$3 or calculat\$3) with optical with signal\$1 with parameter\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	·

	Type	Hits	Search Text	DBs	Time Stamp	Comments
7 6 7	BRS	· · · ·	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (determin\$3 or calculat\$3) with optical with signal\$1 with parameter\$1 with interpolat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	
50	BRS	0	Levenberg-Marquardt with algorithm with interpolat\$3 with point\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 09:15	
51	BRS	56	Levenberg-Marquardt with algorithm and interpolat\$3 with point\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM IDB	2005/04/20 12:38	
52	BRS	0	Levenberg-Marquardt with algorithm same interpolat\$3 with point\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 09:15	
53	BRS	2	"20020038196"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 09:49	

diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or brace adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3	 librar\$3) with			
structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3	7: 6-2-1-2-1-2-1-1-1-1-1-1-1-1-1-1-1-1-1-1-			
(Semiconductor\$1 or US-PGPUB; wafer\$1 or IC\$1 or USPAT; EPO; integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3	 くまます () ***			
(semiconductor\$1 or Wafer\$1 or IC\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3	 מנד תכנתו על די מוומ			
wafer\$1 or IC\$1 or USPAT; EPO; USPAT; EPO; or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3	 (semiconductor\$1 or	- GIIG - GIID •		
integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3	wafer\$1 or IC\$1 or			
IBM_TDB	integrated adj circuit\$1	USPAI; EFO;	7005/04/20	
<u>د</u>	or die\$1 or chip\$1) and	OFO: DERWENT:	7 · · · · ·	
librar\$3) with interpolat\$3	(database\$1 or profile or			
interpolat\$3	librar\$3) with	,		
	interpolat\$3			

Comments

Time Stamp

DBs

Search Text

Hits

Type

2005/04/20 09:59

JPO; DERWENT;

IBM_TDB

approximat\$3 with optical

with signal\$1 with

diffract\$3 with

parameter\$1

structure\$1 and

integrated adj circuit\$1

BRS

54

(semiconductor\$1 or

structure\$1 and

diffract\$3 with

vafer\$1 or IC\$1 or

or die\$1 or chip\$1) and

USPAT; EPO;

US-PGPUB;

2005/04/20

10:00

JPO; DERWENT;

IBM_TDB

(database\$1 or profile or

integrated adj circuit\$1

BRS

55

(semiconductor\$1 or

vafer\$1 or IC\$1 or

or die\$1 or chip\$1) and

JSPAT; EPO;

US-PGPUB;

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
57	BRS	<u>o</u>	diffract\$3 with structure\$1 and (semiconductor\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3 with theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:03	
58	BRS	<u></u>	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with (insert\$3 or interpolat\$3) with theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:04	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
59	BRS	15	diffract\$3 with structure\$1 and (semiconductor\$1 or lC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and (insert\$3 or interpolat\$3) with theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:04	
09	BRS	9	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) with interpolat\$3 with model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:15	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
61	BRS	_	nith and or\$1 or (C\$1 or (d) circuit\$1 chip\$1) and or profile or (d interpolat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:16	
62	BRS	16	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and Levenberg-Marquardt	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:23	
63	BRS	195	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:23	

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
64	BRS	1.1	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 with theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:23	
65	BRS	23	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 same theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:34	
99	BRS	23	diffract\$3 with structure\$1 and (semiconductor\$1 or untegrated adj circuit\$1 or die\$1 or chip\$1) and or die\$1 or chip\$1) and librar\$3) and interpolat\$3 same theoretic\$4 and fit\$4	S-PGPUB; SPAT; EPO; PO; DERWENT; BM_TDB	2005/04/20 10:25	·

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
67	BRS	. 06	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 and theoretic\$4 and fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:26	
89	BRS	4 1	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 and theoretic\$4 and (contin\$7 or iterative\$2 or repeat\$4) with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
69	BRS	0	diffract\$3 with structure\$1 and (semiconductor\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 with equal with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:34	
02	BRS	Ŋ	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IC\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 with equal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:36	

	Туре	Hits	Search Text	DBs	Time Stamp	Comments
71	BRS	23	diffract\$3 with structure\$1 and (semiconductor\$1 or wafer\$1 or IÇ\$1 or integrated adj circuit\$1 or die\$1 or chip\$1) and (database\$1 or profile or librar\$3) and interpolat\$3 same theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 10:37	
72	IS&R	7	("5877859").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 10:38	
73	IS&R	. 2	("5830611").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 10:38	
74	IS&R	7	("5867276").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 10:38	
75	BRS	5 6 7	parameter\$1 with optical with fit\$4 and interpolat\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 11:45	

	Type	Hits	Search Text	DBs	Time Stamp	Comments
92	BRS	1	Levenberg-Marquardt with algorithm and interpolat\$3 with best with fit\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 12:43	
77	BRS	89	interpolat\$3 with best with fit\$4 and theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/04/20 12:43	
78	BRS	42	interpolat\$3 with best with fit\$4 and theoretic\$4 and model\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 12:44	
79	BRS	11	interpolat\$3 with model\$1 and interpolat\$3 with best with fit\$4 and theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 12:45	•
80	BRS		interpolat\$5 with model\$1 and interpolat\$3 with best with fit\$4 and theoretic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 12:45	
81	BRS	2336	702/23,32,33,40,179,182.cc ls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 13:07	

Туре	Hits	Search Text	DBs	Time Stamp	Comments
BRS	1771	250/341.4,226.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 13:13	
BRS	9422	356/432,445,601-625,635- 640,237.1,237.2.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/04/20 13:13	

82